

4.0x4.0mm RIGHT ANGLE SURFACE MOUNT **LED LAMP**

PRELIMINARY SPEC

Part Number: AA4040SURCK

Hyper Red

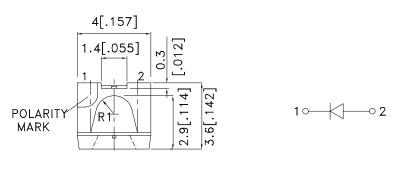
Features

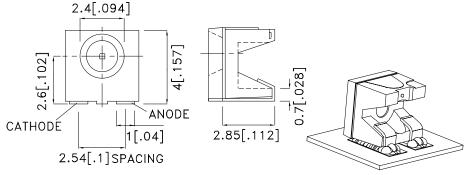
- SINGLE COLOR.
- SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- AVAILABLE ON TAPE AND REEL.
- IDEAL FOR BACKLIGHTING.
- PACKAGE: 500PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

Description

The Hyper Red source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

Package Dimensions





- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAA5292 **REV NO: V.6 DATE: MAY/08/2007** APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.L.LI

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Selection Guide

Part No.	Dice	Dice Lens Type lv (mcd) [2] @ 20mA		,	Viewing Angle [1]
			Min.	Тур.	201/2
AA4040SURCK	Hyper Red (InGaAIP)	WATER CLEAR	70	180	90°

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	635		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	1.95	2.5	V	IF=20mA
lR	Reverse Current	Hyper Red		10	uA	V _R =5V

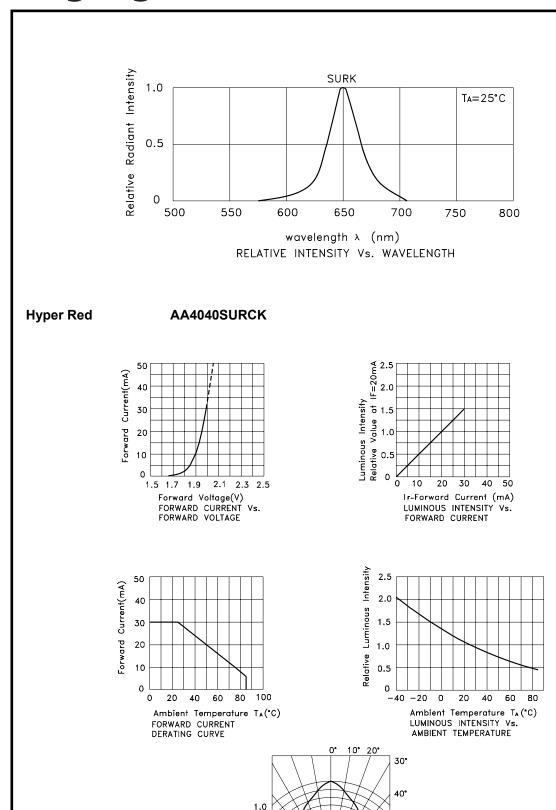
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Hyper Red	Units	
75	mW	
30	mA	
185	mA	
5	V	
-40°C To +85°C		
-40°C To +85°C		
	30 185 5 -40°C To +85°C	

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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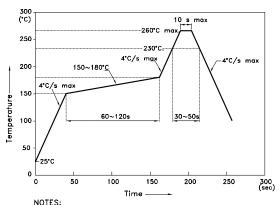
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SPATIAL DISTRIBUTION

50° 60° 70° 80° 90°

AA4040SURCK

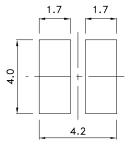
Reflow Soldering Profile For Lead-free SMT Process.



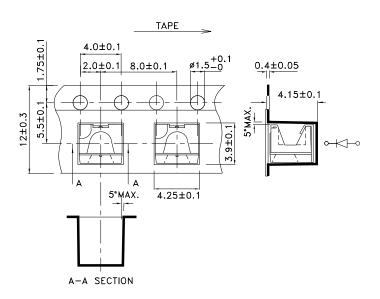
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



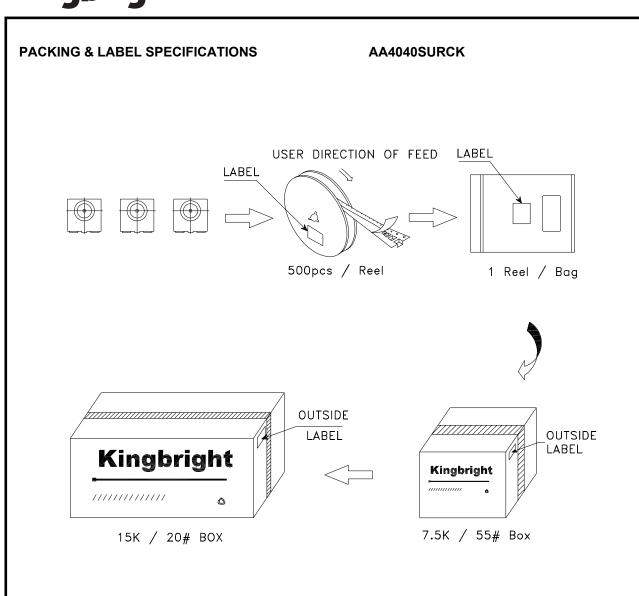
Tape Specifications (Units: mm)



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